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| Application Number:                  | 10599440  |  |  |  |  |
| International Application Number:    |   |  |  |  |  |
| Confirmation Number:                 | 8901  |  |  |  |  |
| Title of Invention:                  | Silicon electrode plate for plasma etching with superior durability |  |  |  |  |
| First Named Inventor/Applicant Name: | Hideki Fujiwara   |  |  |  |  |
| Customer Number:                     | 07278   |  |  |  |  |
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| Application Type:                    | U.S. National Stage under 35 USC 371                                |  |  |  |  |

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| 5   | Foreign Reference   | JP2003-137687.PDF   | 48aaa4dd173ed4e30309d5d94e655845d8<br>706bca   |                             | 6                     |
|   |   |   | 275624   | no                          |                       |
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| 7   | roleignmeletenee  | JP2002-299345.PDF   | 874603b99f63d689f76465f6587f95c111b8<br>532d   | no                          | 5                     |
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|   | Information Disclosure Statement (IDS)  |   | 610298   |                             | 4                     |
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| 2   | NPL Documents   | JP_OA.PDF   | 56fa096997196f4261614e80dc68f59d2cd8<br>855e   | no                          | 5                     |
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